

CLAIMS

1. A synthetic resin card comprising:

a substantially planar core layer; and

5 a first outer layer and a second outer layer laminated
on front and back surfaces of the core layer, respectively,
wherein the difference Δ in the angle of orientation
between the first and second outer layers is 20° or less.

2. The synthetic resin card according to Claim 1, wherein
10 the thicknesses of the first and second outer layers are
symmetrical with respect to the core layer.

3. The synthetic resin card according to Claim 1, wherein
the first and second outer layers each have a thickness of
25 to 125 μm .

15 4. The synthetic resin card according to Claim 1, wherein
the first and second outer layers are each formed of a
biaxially oriented film.

5. The synthetic resin card according to Claim 4, wherein
the biaxially oriented film is composed of an oriented PET
20 material.

6. The synthetic resin card according to Claim 1, wherein
the core layer comprises an electronic module sandwiched
between a pair of core components.

7. The synthetic resin card according to Claim 6, wherein
25 the electronic module comprises an IC chip and an IC module

connected to the IC chip.

8. The synthetic resin card according to Claim 1, wherein at least one of the first outer layer and the second outer layer is provided with a recording layer.

5 9. The synthetic resin card according to Claim 8, wherein the recording layer is composed of a reversible thermosensitive material.

10 10. The synthetic resin card according to Claim 1, wherein the core layer is composed of a copolymer of terephthalic acid, cyclohexanedimethanol, and ethylene glycol, and polycarbonate, the compounding ratio of the copolymer being 70% or less.

15 11. The synthetic resin card according to Claim 1, wherein the core layer and the first and second outer layers are each composed of a halogen-free material.

12. A method for producing a synthetic resin card comprising laminating a first outer layer and a second outer layer on front and back surfaces of a substantially planar core layer,

20 wherein the first and second outer layers are selected so that the difference Δ in the angle of orientation between the first and second outer layers is 20° or less; and

the first and second outer layers are laminated so that the thicknesses of the first and second outer layers are
25 symmetrical with respect to the core layer.